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Kind regards,

Team Nexperia



PNP resistor-equipped transistor; $R1 = 4.7 \text{ k}\Omega$, R2 = openRev. 2 — 4 May 2012

Product data sheet

Product profile 1.

1.1 General description

PNP Resistor-Equipped Transistor (RET) in a leadless ultra small DFN1006B-3 (SOT883B) Surface-Mounted Device (SMD) plastic package.

NPN complement: PDTC143TMB.

1.2 Features and benefits

- 100 mA output current capability
- Reduces component count
- Built-in bias resistors
- Reduces pick and place costs

1.3 Applications

- Low-current peripheral driver
- Control of IC inputs

- Simplifies circuit design
- AEC-Q101 gualified
- Leadless ultra small SMD plastic package
- Low package height of 0.37 mm
- Replaces general-purpose transistors in digital applications
- Mobile applications

1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	-50	V
lo	output current		-	-	-100	mA
R1	bias resistor 1 (input)	T _{amb} = 25 °C	3.3	4.7	6.1	kΩ



PNP resistor-equipped transistor; R1 = 4.7 k Ω , R2 = open

2. Pinning information

Table 2.	Pinning	j information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I	input (base)		
2	G	GND (emitter)		3
3	0	output (collector)	2 Transparent top view SOT883B (DFN1006B-3)	1 2 sym009

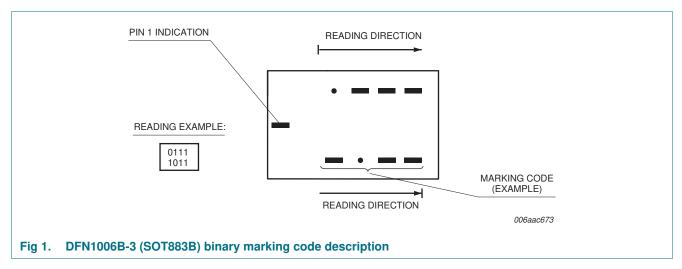
3. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
PDTA143TMB	DFN1006B-3	Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.37 mm	SOT883B		

4. Marking

Table 4.	Marking	codes
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Type number	Marking code
PDTA143TMB	0010 1000



PNP resistor-equipped transistor; R1 = 4.7 k Ω , R2 = open

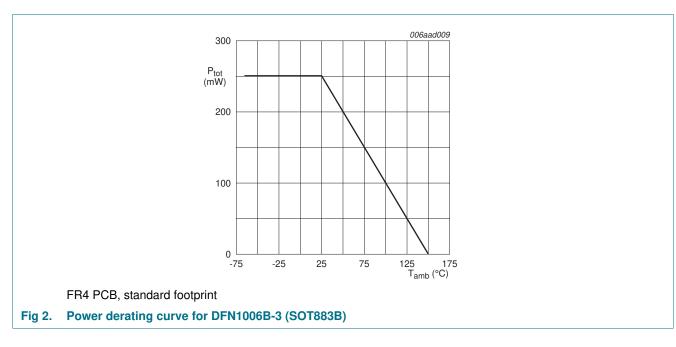
5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	-50	V
V _{CEO}	collector-emitter voltage	open base		-	-50	V
V _{EBO}	emitter-base voltage	open collector		-	-5	V
I _O	output current			-	-100	mA
I _{CM}	peak collector current	pulsed; t _p ≤ 1 ms		-	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	<u>[1]</u>	-	250	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

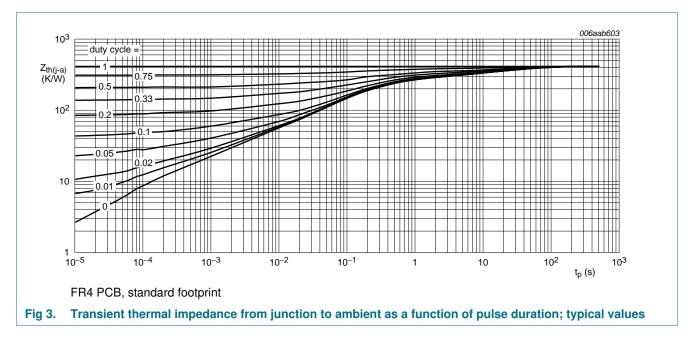


PNP resistor-equipped transistor; R1 = 4.7 k Ω , R2 = open

6. Thermal characteristics

Table 6.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u>	-	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



7. Characteristics

Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V}; \text{ I}_{E} = 0 \text{ A}; \text{ T}_{amb} = 25 \text{ °C}$	-	-	-100	nA
I _{CEO}	collector-emitter cut-off	V_{CE} = -30 V; I _B = 0 A; T _{amb} = 25 °C	-	-	-1	μA
	current	V_{CE} = -30 V; I _B = 0 A; T _j = 150 °C	-	-	-5	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0 \text{ A}; \text{ T}_{amb} = 25 \text{ °C}$	-	-	-100	nA
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -1 \text{ mA}; \text{ T}_{amb} = 25 \text{ °C}$	200	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = -5 \text{ mA}; I_{B} = -0.25 \text{ mA}; T_{amb} = 25 \text{ °C}$	-	-	-150	mV
R1	bias resistor 1 (input)	T _{amb} = 25 °C	3.3	4.7	6.1	kΩ
C _C	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = -10 \text{ V}; \text{ I}_{E} = 0 \text{ A}; \text{i}_{e} = 0 \text{ A}; \\ \text{f} = 1 \text{ MHz}; \text{T}_{amb} = 25 ^{\circ}\text{C} \end{array}$	-	-	3	pF
f _T	transition frequency	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -10 \text{ mA}; \text{ f} = 100 \text{ MHz};$ 1 $T_{amb} = 25 \text{ °C}$	-	180	-	MHz

[1] Characteristics of built-in transistor.

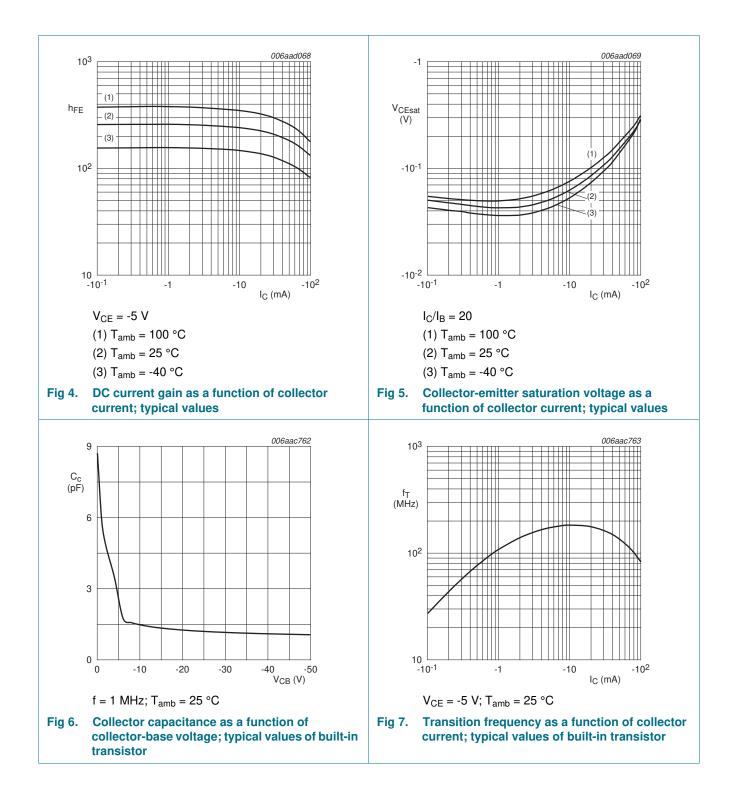
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PDTA143TMB

NXP Semiconductors

PDTA143TMB

PNP resistor-equipped transistor; R1 = 4.7 k Ω , R2 = open



PDTA143TMB

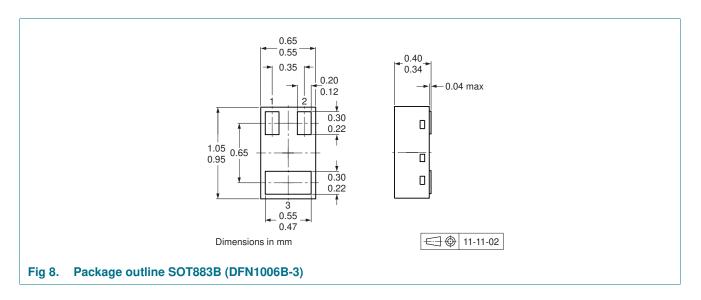
PNP resistor-equipped transistor; R1 = 4.7 k Ω , R2 = open

8. Test information

8.1 Quality information

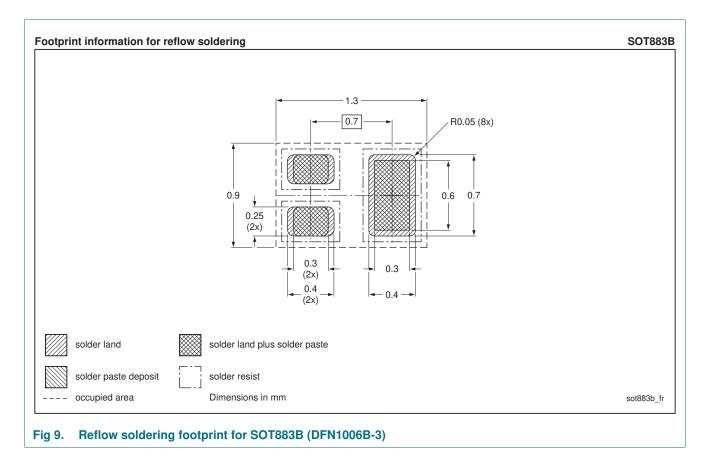
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

9. Package outline



PNP resistor-equipped transistor; R1 = 4.7 k Ω , R2 = open

10. Soldering



PNP resistor-equipped transistor; R1 = 4.7 k Ω , R2 = open

11. Revision history

Table 8. Revision	history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PDTA143TMB v.2	20120504	Product data sheet	-	PDTA143TMB v.1
Modifications:	7 "Characteristic	<u>s"</u> : parameter name corre	cted	
PDTA143TMB v.1	20122504	Product data sheet	-	-

PNP resistor-equipped transistor; $R1 = 4.7 \text{ k}\Omega$, R2 = open

12. Legal information

12.1 Data sheet status

Document status ^[1] ^[2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Product data sheet

PDTA143TMB

PNP resistor-equipped transistor; $R1 = 4.7 \text{ k}\Omega$, R2 = open

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14. Contents

1	Product profile1
1.1	General description1
1.2	Features and benefits1
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Marking
5	Limiting values
6	Thermal characteristics4
7	Characteristics4
8	Test information6
8.1	Quality information6
9	Package outline6
10	Soldering7
11	Revision history8
12	Legal information9
12.1	Data sheet status9
12.2	Definitions9
12.3	Disclaimers9
12.4	Trademarks
13	Contact information10

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